





Dow at K 2013 Seminar Schedule

Wednesday, 16 October	Thursday, 17 October	Friday, 18 October	Monday, 21 October	Tuesday, 22 October
Introducing a Breakthrough in Polyolefin Compatibilization Technology <i>An invitation only event</i> 14:30–15:30 AUD 1601	SEALUTION™ Breakfast 9:30–10:30 MR 1701	Introducing Ultrasonic Sealing Solutions as Alternative Heat Conductive Sealing 10:30–11:30 MR 1801	Collaborative Packaging Innovation Throughout the Value Chain 10:00–11:00 MR 2101	SEALUTION™ Breakfast 9:30–10:30 MR 2201
Happy Birthday INFUSE™ Olefin Block Copolymers! <i>An invitation only event</i> 16:00–18:00 AUD 1602	Collaborative Packaging Innovation Throughout the Value Chain 11:00–12:00 MR 1702	From Global Megatrends to Food Packaging Science 12:00–13:00 AUD 1802	Introducing New Sealants 12:00–13:00 AUD 2102	New Tielayers Make Better Packaging Solutions 11:00–12:00 MR 2202
	New Tielayers Make Better Packaging Solutions 12:30–13:30 MR 1703	Sustainable End of Life Options for Plastic Packaging 13:30–14:30 AUD 1803	Creating Sustainable Sports Environments of the Future <i>An invitation only event</i> 12:00–13:00 MR 2103	A Pallet Travels the World – Requirements and Trends in Modern Logistics Packaging 12:30–14:00 MR 2203
	Introducing New Sealants 13:30–14:30 AUD 1704	A Pallet Travels the World – Requirements and Trends in Modern Logistics Packaging 13:30–15:00 MR 1804	Do you Agree That Less is More? Thinner and Stronger Films for Collation Packaging 14:00–15:00 MR 2104	Breaking Barriers in Hygiene 15:00–17:00 AUD 2204
	Exploring the Pouch 2.0 16:30–17:30 AUD 1705	Celebrating 50 Years of Sustained Leadership with NORDEL™ IP <i>An invitation only event</i> 15:00–16:00 AUD 1805	How Packaging Contributes to a Sustainable Society: Feeding the Planet and Preserving our Environment by Reducing Food Waste 15:00–16:00 AUD 2105	
		Do you Agree That Less is More? Thinner and Stronger Films for Collation Packaging 15:30–16:30 MR 1806	From Global Megatrends to Food Packaging Science 16:30–17:30 AUD 2106	
			Introducing Ultrasonic Sealing Solutions as Alternative Heat Conductive Sealing 17:00–18:00 MR 2107	

	Business Center Auditorium
	Conference Room 9

For more information on our presence at K 2013, please visit our dedicated homepage: www.dow-K2013.com